

Product Summary

| V _{(BR)DS} S | RDS(ON) Max | Package | Ι _D T _A = +25°C |
|--------------------------|-----------------------------|---------|--|
| -30V | $25m\Omega @V_{GS} = -10V$ | SO-8 | -6.0 A |
| -307 | $38m\Omega @V_{GS} = -4.5V$ | 30-0 | -4.7A |

Description

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- DC-DC Converters
- Power Management Functions
- Load Switch

Features

- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)

30V DUAL P-CHANNEL ENHANCEMENT MODE MOSFET

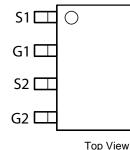
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 standards for High Reliability

Mechanical Data

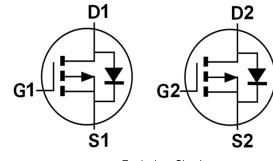
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208 ⁽³⁾
- Weight: 0.074 grams (approximate)



Top View







Equivalent Circuit

Ordering Information (Note 4)

| Case | Packaging |
|------|-------------------|
| SO-8 | 2,500/Tape & Reel |
| - | Case |

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

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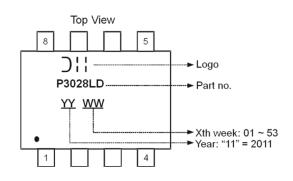
 \Box D2

 $\Box D2$

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html

Marking Information





Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | | Symbol | Value | Units |
|---|-----------------|--|-----------------|--------------|-------|
| Drain-Source Voltage | | V _{DSS} | -30 | V | |
| Gate-Source Voltage | | V _{GSS} | ±20 | V | |
| | Steady State | T _A = +25°C T _A = +70°C | ID | -6 -4.7 | A |
| Continuous Drain Current (Note 5) V _{GS} = 10V | t<10s | T _A = +25°C T _A = +70°C | ID | -7.4 -5.8 | А |
| Maximum Body Diode Forward Current (Note 6) | ls | -2.5 | А | | |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | | | I _{DM} | -30 | А |

Thermal Characteristics

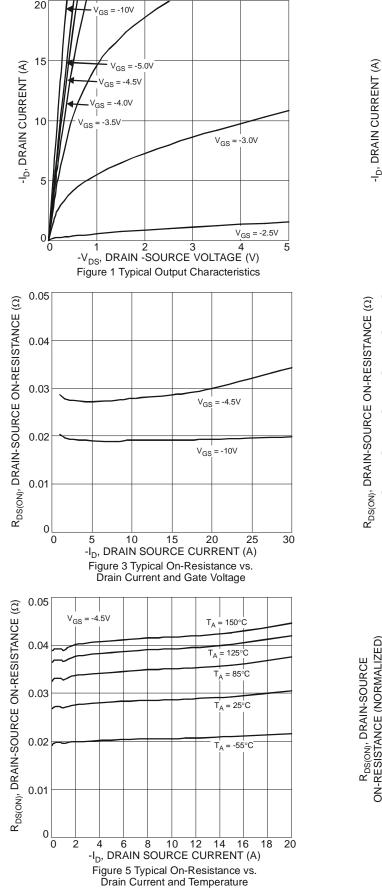
| Characteristic | | Symbol | Value | Units |
|--|------------------------|------------------|-------------|-------|
| Total Dawar Dissinction (Nata 5) | T _A = +25°C | D | 1.3 | W |
| Total Power Dissipation (Note 5) | $T_A = +70^{\circ}C$ | PD | 0.8 | |
| Thermal Desistance, Junction to Ambient (Note 5) | Steady state | D. | 102 | °C/W |
| Thermal Resistance, Junction to Ambient (Note 5) | t<10s | R _{0JA} | 61 | |
| Total Bower Dissinction (Note 6) | $T_A = +25^{\circ}C$ | D | 1.7 | W |
| Total Power Dissipation (Note 6) | T _A = +70°C | PD | 1.1 | |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady state | D. | 75 | °C/W |
| mermai Resistance, Junction to Ambient (Note 6) | t<10s | Røja | 50 | |
| Thermal Resistance, Junction to Case (Note 6) | Rejc | 14.5 | | |
| Operating and Storage Temperature Range | | TJ. TSTG | -55 to +150 | °C |

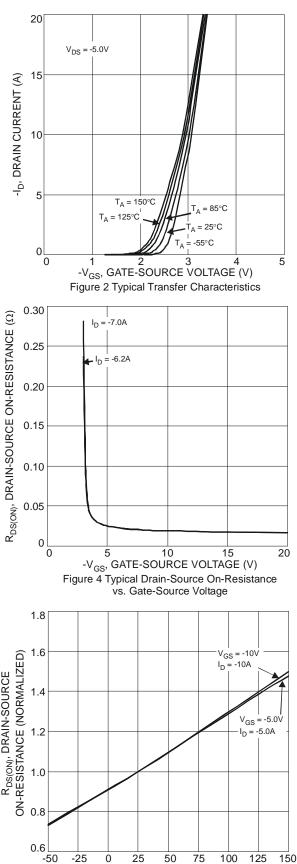
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|---|---------------------|-----|------|------|--------|--|--|
| OFF CHARACTERISTICS (Note 7) | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | -30 | _ | — | V | $V_{GS} = 0V, I_D = -250 \mu A$ | |
| Zero Gate Voltage Drain Current | I _{DSS} | — | - | -1 | μA | $V_{DS} = -30V, V_{GS} = 0V$ | |
| Gate-Source Leakage | I _{GSS} | — | - | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 7) | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | -1 | — | -3 | V | $V_{DS} = V_{GS}$, $I_D = -250 \mu A$ | |
| Static Drain-Source On-Resistance | Proven | — | 20 | 25 | mΩ | $V_{GS} = -10V, I_D = -7A$ | |
| Static Drain-Source On-resistance | R _{DS(ON)} | — | 29 | 38 | 1115.2 | $V_{GS} = -4.5V, I_D = -5.5A$ | |
| Forward Transfer Admittance | Y _{fs} | _ | 11 | — | S | $V_{DS} = -5V, I_D = -7A$ | |
| Diode Forward Voltage | V _{SD} | — | 0.7 | 1.2 | V | $V_{GS} = 0V, I_{S} = -2.1A$ | |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | | |
| Input Capacitance | Ciss | — | 1241 | — | | V _{DS} = -15V, V _{GS} = 0V f = 1.0MHz | |
| Output Capacitance | C _{oss} | — | 147 | — | pF | | |
| Reverse Transfer Capacitance | Crss | — | 110 | — | | 1 = 1.000112 | |
| Gate Resistance | R _G | — | 15 | — | Ω | $V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$ | |
| Total Gate Charge (V _{GS} = -4.5V) | Qg | — | 22 | — | | | |
| Total Gate Charge (V _{GS} = -10V) | Qg | — | 10.9 | — | nC | V _{DS} = -15V, I _D = -7A | |
| Gate-Source Charge | Q _{gs} | _ | 3.5 | — | nc | | |
| Gate-Drain Charge | Q _{gd} | _ | 4.7 | — | | | |
| Turn-On Delay Time | t _{D(on)} | _ | 9.7 | _ | | V _{GS} = -10V, V _{DD} = -15V, R _{GEN} = 6Ω, | |
| Turn-On Rise Time | tr | _ | 17.1 | — | nS | | |
| Turn-Off Delay Time | t _{D(off)} | — | 60.5 | _ | 113 | I _D = -7A | |
| Turn-Off Fall Time | t _f | | 40.4 | |] | | |

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing. Notes:

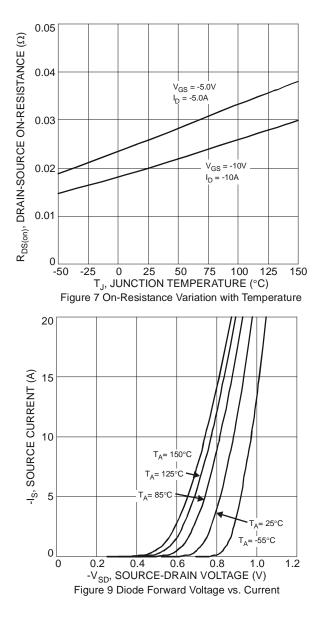


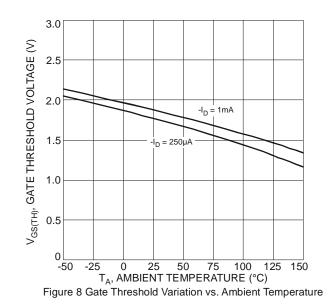




T_J, JUNCTION TEMPERATURE (°C) Figure 6 On-Resistance Variation with Temperature



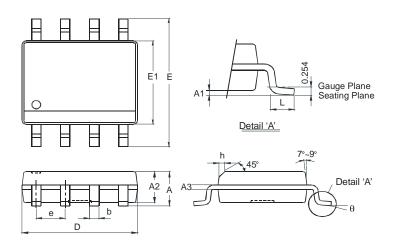






Package Outline Dimensions

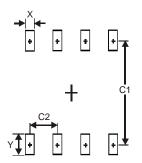
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| | SO-8 | | | | | |
|----------------------|----------|------|--|--|--|--|
| Dim | Min | Max | | | | |
| Α | - | 1.75 | | | | |
| A1 | 0.10 | 0.20 | | | | |
| A2 | 1.30 | 1.50 | | | | |
| A3 | 0.15 | 0.25 | | | | |
| b | 0.3 | 0.5 | | | | |
| D | 4.85 | 4.95 | | | | |
| E | 5.90 | 6.10 | | | | |
| E1 | 3.85 | 3.95 | | | | |
| е | 1.27 Typ | | | | | |
| h | - | 0.35 | | | | |
| L | 0.62 | 0.82 | | | | |
| Θ | 0° | 8° | | | | |
| All Dimensions in mm | | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Х | 0.60 |
| Y | 1.55 |
| C1 | 5.4 |
| C2 | 1.27 |



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